

MOSFET Silicon N-Channel MOS



1. Applications

Soft Switching Boost PFC switch, Half bridge or Asymmetric half bridge or Series resonance half bridge and full bridge topologies.
 phase-shift-bridge(ZVS), LLC Application-Server Power, Telecom Power, EV Charging, Solar inverter.

2. Features

Low drain-source on-resistance: $R_{DS(ON)} = 0.080\Omega$ (typ.)
 Easy to control Gate switching
 Enhancement mode: $V_{th} = 3$ to 5V

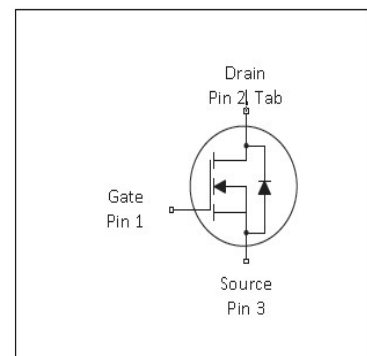


Table 1 Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	650	V
$R_{DS(on),max}$	90	m Ω
$Q_{g,typ}$	65	nC
$I_{D,pulse}$	141	A
Body diode dv/dt	50	V/ns

3. Packaging and Internal Circuit

Part Name	Package	Marking
ASW60R090EFD	TO247	ASW60R090EFD
ASA60R090EFD	TO220F	ASA60R090EFD



1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current ¹⁾	I_D		-	47	A	$T_C = 25^\circ\text{C}$
Pulsed drain current ²⁾	$I_{D,pulse}$	-	-	141	A	$T_C = 25^\circ\text{C}$
Avalanche energy, single pulse	E_{AS}	-	-	5336	mJ	
MOSFET dv/dt ruggedness	dv/dt	-	-	59	V/ns	$V_{DS} = 0 \dots 400\text{V}$
Gate source voltage (static)	V_{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC ($f > 1\text{ Hz}$)
Power dissipation(TO220F)	P_{tot}	-	-	34	W	$T_C = 25^\circ\text{C}$
Power dissipation(TO247)	P_{tot}	-	-	391	W	$T_C = 25^\circ\text{C}$
Storage temperature	T_{stg}	-55	-	150	$^\circ\text{C}$	
Operating junction temperature	T_j	-55	-	150	$^\circ\text{C}$	
Reverse diode dv/dt ³⁾	dv/dt	-	-	50	V/ns	$V_{DS} = 0 \dots 400\text{V}$, $I_{SD} \leq 48\text{A}$, $T_j = 25^\circ\text{C}$ see table 8

release

¹⁾ Limited by $T_{j,max}$. Maximum Duty Cycle $D = 0.50$

²⁾ Pulse width t_p limited by $T_{j,max}$

³⁾ Identical low side and high side switch with identical R_G

2 Thermal characteristics

Table 3 Thermal characteristics(TO220F)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	3.65	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	80	°C/W	device on PCB, minimal footprint

Thermal characteristics (TO247)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	0.32	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	device on PCB, minimal footprint

release

3 Electrical characteristics

at $T_j=25^{\circ}\text{C}$, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	605	-	-	V	$V_{GS}=0V, I_D=10mA$
Gate threshold voltage	$V_{(GS)th}$	3		5	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Zero gate voltage drain current	I_{DSS}	-	-	5	μA	$V_{DS}=600V, V_{GS}=0V, T_j=25^{\circ}\text{C}$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=30V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	0.080	0.090	Ω	$V_{GS}=10V, I_D=20A, T_j=25^{\circ}\text{C}$
Gate resistance (Intrinsic)	R_G	-	14	-	Ω	$f=1MHz, \text{open drain}$

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	4799	-	pF	$V_{GS}=0V, V_{DS}=50V, f=10kHz$
Output capacitance	C_{oss}	-	482	-	pF	$V_{GS}=0V, V_{DS}=50V, f=10kHz$
Reverse transfer capacitance	C_{rss}	-	4.6	-	pF	$V_{GS}=0V, V_{DS}=50V, f=10kHz$
Turn-on delay time	$t_{d(on)}$	-	38.8	-	ns	$V_{DD}=400V, V_{GS}=13V, I_D=25.8A$ $R_G=1.7\Omega$; see table 9
Rise time	t_r	-	26.8	-	ns	$V_{DD}=400V, V_{GS}=13V, I_D=25.8A$ $R_G=1.7\Omega$; see table 9
Turn-off delay time	$t_{d(off)}$	-	134.8	-	ns	$V_{DD}=400V, V_{GS}=13V, I_D=25.8A$ $R_G=1.7\Omega$; see table 9
Fall time	t_f	-	20	-	ns	$V_{DD}=400V, V_{GS}=13V, I_D=25.8A$ $R_G=1.7\Omega$; see table 9

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	20	-	nC	$V_{DD}=400V, I_D=25.8A, V_{GS}=0 \text{ to } 10V$
Gate to drain charge	Q_{gd}	-	24	-	nC	$V_{DD}=400V, I_D=25.8A, V_{GS}=0 \text{ to } 10V$
Gate charge total	Q_g	-	65	-	nC	$V_{DD}=400V, I_D=25.8A, V_{GS}=0 \text{ to } 10V$
Gate plateau voltage	$V_{plateau}$	-	7.4	-	V	$V_{DD}=400V, I_D=25.8A, V_{GS}=0 \text{ to } 10V$

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	0.66	-	V	$V_{GS}=0V, I_F=1A, T_j=25^{\circ}C$
Reverse recovery time	t_{rr}	-	120.8	-	ns	$V_r=400v, I_F=9.6A, di/dt=100A/us$ see table 8
Reverse recovery charge	Q_{rr}	-	0.7	-	uC	$V_r=400v, I_F=9.6A, di/dt=100A/us$ see table 8
Peak reverse recovery current	I_{rrm}	-	11.3	-	A	$V_r=400v, I_F=9.6A, di/dt=100A/us$ see table 8

release

4 Test Circuits

Table 8 Diode characteristics

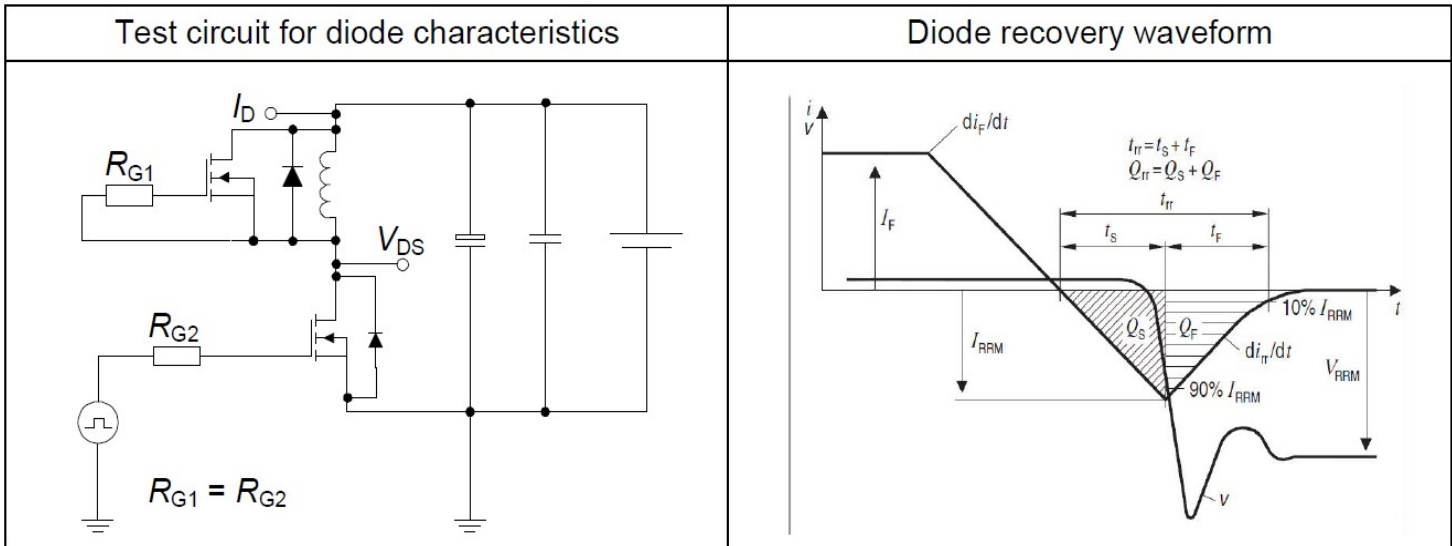


Table 9 Switching times

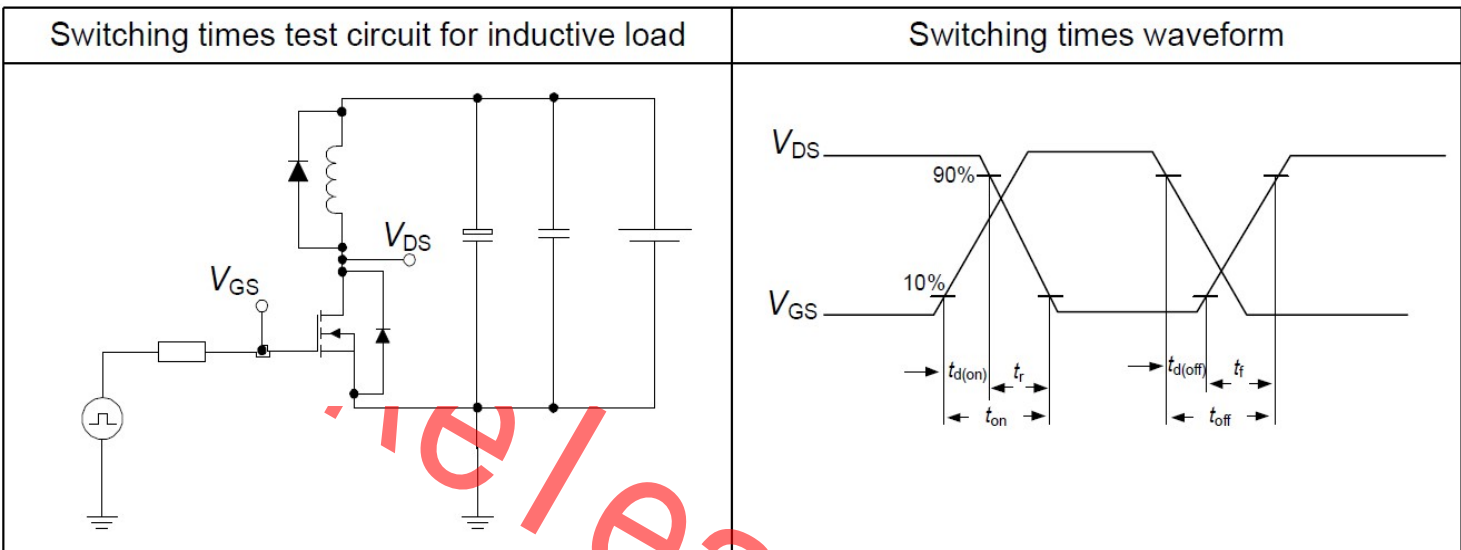
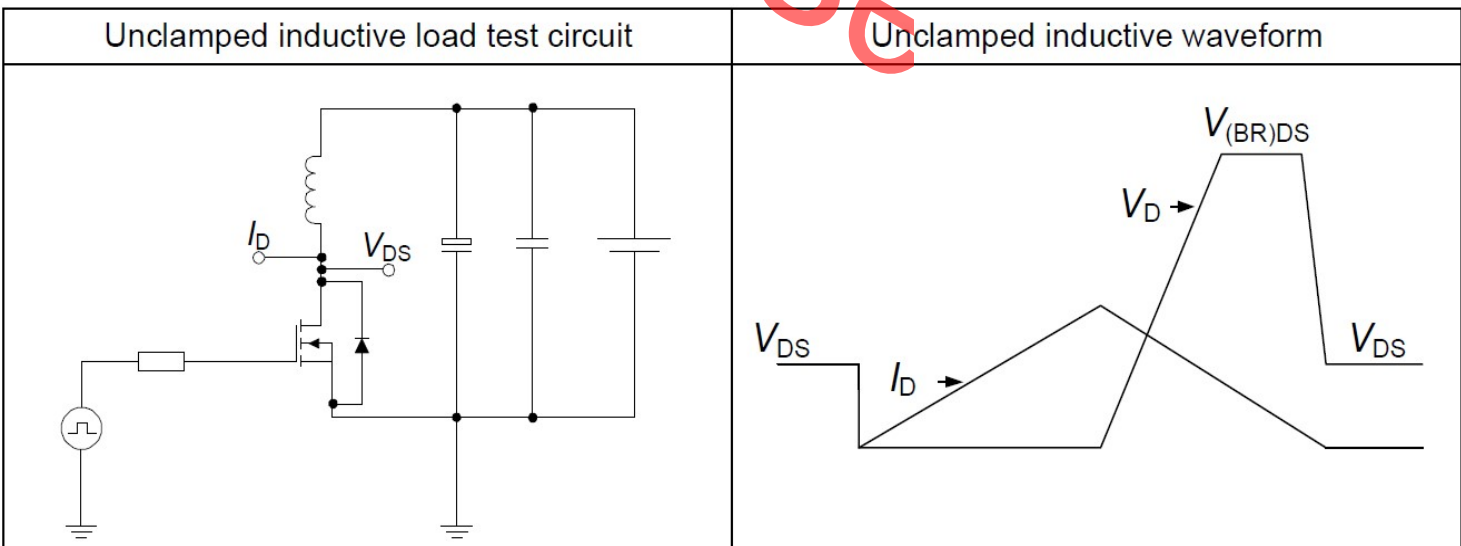


Table10 Unclamped inductive load



5 Package Outlines

TO-220F

单位: mm

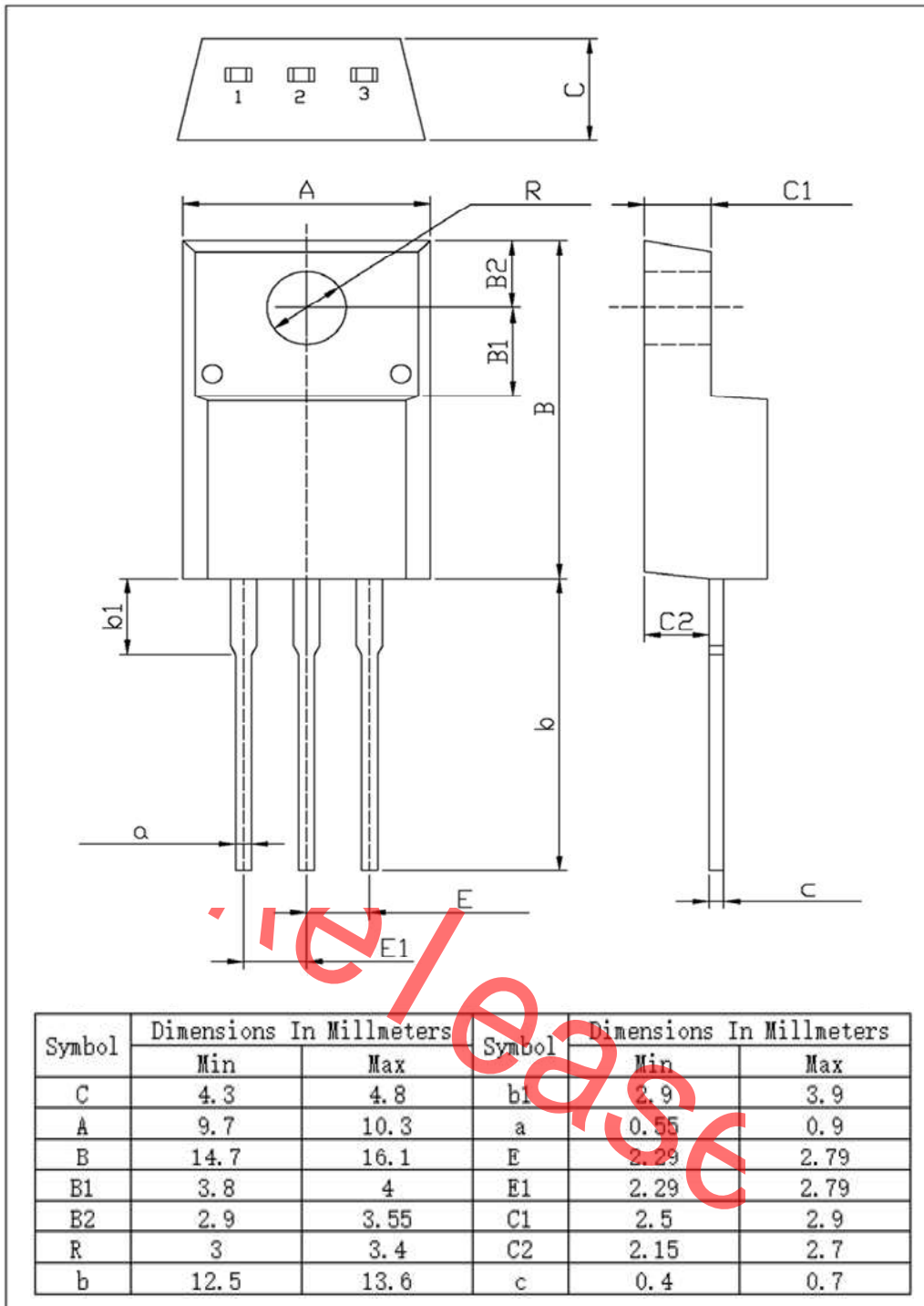
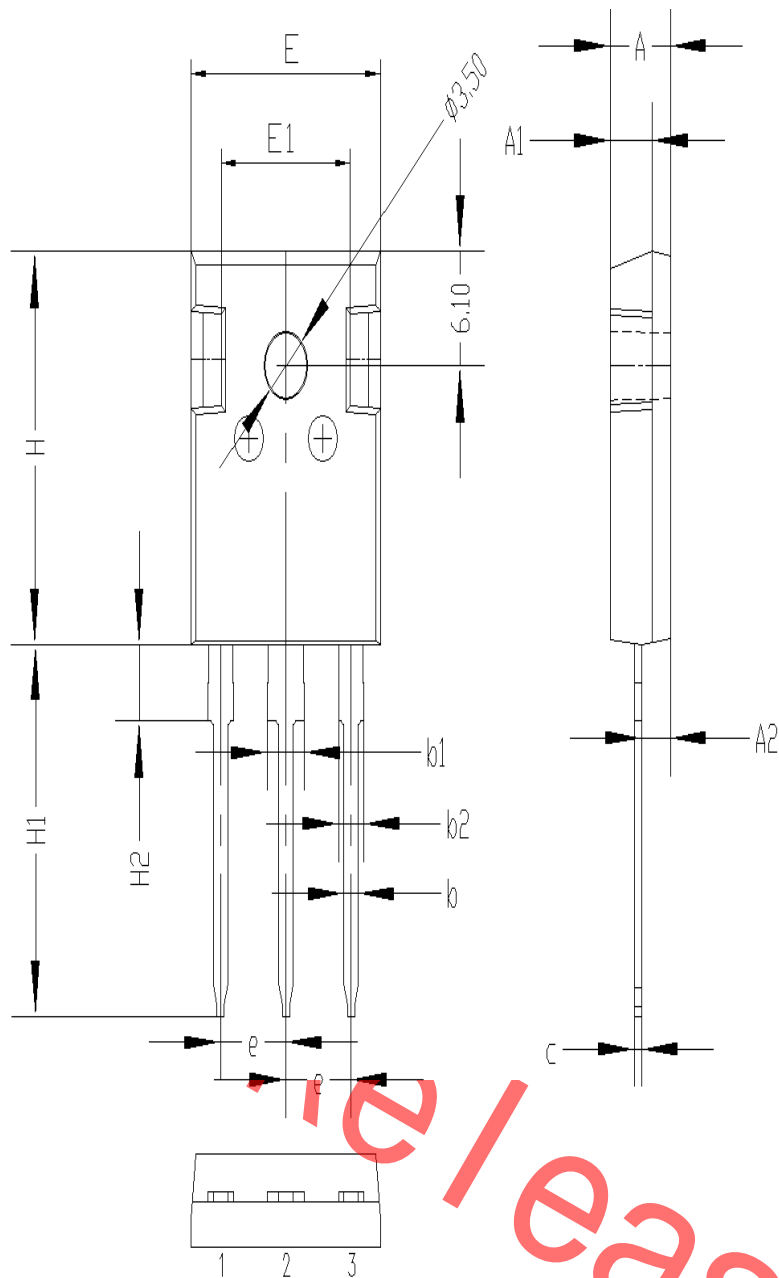


Figure1: Outline PG-T0220F



	單位 mm		
	MIN	NOM	MAX
A	4.8	5	5.2
A1	3.3	3.5	3.7
A2	2.1	2.3	2.5
b	1	1.2	1.4
b1	2.9	3.1	3.3
b2	1.9	2.1	2.3
c	0.4	0.6	0.8
e	5.25	5.45	5.65
E	15.6	15.8	16
E1	10.6	10.8	11
H	20.8	21	21.2
H1	19.4	19.9	20.4
H2	3.9	4.1	4.3
G	5.9	6.1	6.3
ØP	3.3	3.5	3.7

Figure2: Outline PG-T0247

Revision History

Revision	Date	Subjects (major changes since last revision)
0.1	2019-05-21	Preliminary version
1.0	2019-11-07	Fine tune outline and add Crss test data.etc
1.1	2020-03-18	Change part name for revision history
1.2	2020-03-23	Add part name"ASA60R090EFD"

Not for release

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [ANHI](#) manufacturer:

Other Similar products are found below :

[IRFD120](#) [IRFY240C](#) [JANTX2N5237](#) [2SK2267\(Q\)](#) [BUK455-60A/B](#) [MIC4420CM-TR](#) [VN1206L](#) [NDP4060](#) [SI4482DY](#)
[IPS70R2K0CEAKMA1](#) [SQD23N06-31L-GE3](#) [TK16J60W,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#)
[DMN1053UCP4-7](#) [SQJ469EP-T1-GE3](#) [NTE2384](#) [DMC2700UDMQ-7](#) [DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#)
[DMN31D5UDJ-7](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [IRF40H233XTMA1](#) [STU5N65M6](#)
[DMN6022SSD-13](#) [DMN13M9UCA6-7](#) [DMTH10H4M6SPS-13](#) [DMN2990UFB-7B](#) [IPB80P04P405ATMA2](#) [2N7002W-G](#) [MCAC30N06Y-](#)
[TP](#) [MCQ7328-TP](#) [NTMC083NP10M5L](#) [NVMFS2D3P04M8LT1G](#) [BXP7N65D](#) [BXP4N65F](#) [AOL1454G](#) [WMJ80N60C4](#) [BXP2N20L](#)
[BXP2N65D](#) [BXT1150N10J](#) [BXT1700P06M](#) [TSM60NB380CP](#) [ROG](#) [RQ7L055BGTCR](#) [DMNH15H110SK3-13](#)